

Title (en)  
NO-RUB FINISHING COMPOSITIONS

Title (de)  
REIBFREIER DECKLACK

Title (fr)  
COMPOSITIONS DE FINITION SANS PON AGE

Publication  
**EP 1235864 A4 20030226 (EN)**

Application  
**EP 00975438 A 20001027**

Priority  
• US 0029666 W 20001027  
• US 16180499 P 19991027

Abstract (en)  
[origin: WO0130857A1] A self-leveling finishing composition capable of providing chemically resistant low profile coatings is described. The finishing composition comprises thermoplastic resin solids and thermosetting resin solids in a weight ratio of about 0.5:1 to about 11:1 and a solvent composition comprising a solvent capable of dissolving the thermoplastic resin solids component and a solvent miscible co-solvent capable of dissolving the thermosetting resin solids. The finishing composition is applied and dried to a dry-to-touch surface which is thereafter subjected to conditions capable of initiating polymerization of the component thermosetting resin solids. The finishing composition can be used as a substitute for more expensive or more labor intensive coating compositions in existing surface finishing protocols without compromise of surface quality and chemical resistance.

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CPC (source: EP US)  
**C08J 3/091** (2013.01 - EP US); **C09D 7/00** (2013.01 - EP US); **C09D 7/20** (2017.12 - EP US); **C09D 101/14** (2013.01 - EP US); **C09D 101/18** (2013.01 - EP US); **C09D 167/00** (2013.01 - EP US); **C09D 175/16** (2013.01 - EP US); **C09D 201/00** (2013.01 - EP US)

Citation (search report)  
• No further relevant documents disclosed  
• See references of WO 0130857A1

Cited by  
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**WO 0130857 A1 20010503**; AT E301138 T1 20050815; CA 2387396 A1 20010503; CA 2387396 C 20100216; DE 60021759 D1 20050908; DE 60021759 T2 20060601; EP 1235864 A1 20020904; EP 1235864 A4 20030226; EP 1235864 B1 20050803; ES 2249303 T3 20060401; MX PA02004051 A 20030922; US 6632852 B1 20031014

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